+357 96 030922
info@marketpublishers.com

Global QFN Leadframe Backside Tape Supply, Demand and Key Producers, 2026-2032

https://marketpublishers.com/r/GB0E22C25349EN.html
Date: November 2026
Pages: 119
Price: US$ 4,480.00 (Single User License)
ID: GB0E22C25349EN

Abstracts

The global QFN Leadframe Backside Tape market size is expected to reach $ 409 million by 2032, rising at a market growth of 4.7% CAGR during the forecast period (2026-2032).

QFN Leadframe Backside Tape refers to a specialized temporary high-temperature adhesive tape applied to the reverse side of metal leadframes during the assembly of Quad Flat No-Lead, Dual Flat No-Lead, Small Outline No-Lead, Mini-QFN and related leadless semiconductor packages. The tape temporarily seals exposed leadframe openings and terminal areas during epoxy molding compound encapsulation, preventing resin leakage, mold flash and burr formation while maintaining sufficient leadframe flatness and process stability for wire bonding, molding and subsequent package processing. Commercial products generally use heat-resistant polyimide film as the primary substrate, although polyester, fluoropolymer and composite films can be used for specific process conditions, combined with silicone, acrylic, epoxy-modified or hybrid pressure-sensitive adhesive systems. Key performance requirements include stable adhesion and dimensional behavior under semiconductor processing temperatures, generally around 180–260°C depending on process design, low outgassing, controlled peel force, low ionic contamination, good wetting to copper leadframes and pre-plated frames, resistance to epoxy bleed, and clean removal without adhesive residue after molding. The study focuses on temporary backside tapes used during leadframe-based mold encapsulation and covers both pre-applied and post-wire-bonding tape processes for QFN-family and related leadless packages.

Key Findings

+357 96 030922
info@marketpublishers.com

Polyimide film combined with silicone or acrylic adhesive remains the mainstream QFN backside tape structure

QFN packaging represents the largest application, followed by DFN and other leadless package configurations

The 2025 global manufacturer-level average selling price is estimated at approximately US$30 per square meter

Heat resistance, residue-free removal and EMC leakage control are the principal product performance differentiators

Japan, South Korea and Taiwan form the core high-performance supply base, with China developing local alternatives

Market Trends

QFN Leadframe Backside Tape is evolving toward thinner, cleaner and more thermally stable material systems as leadless packages become smaller, lead pitches tighten and semiconductor assembly temperatures increase. Traditional silicone-based polyimide tape remains widely used because it provides high-temperature resistance and stable peel behavior, while acrylic and hybrid adhesive systems are being developed for processes requiring lower silicone transfer, stronger plasma-cleaning compatibility or more controlled surface interaction with copper and pre-plated leadframes. Koan Hao, for example, offers both acrylic-PSA and silicone-PSA QFN tapes with maximum temperature resistance of 260°C, illustrating the industry's move toward multiple adhesive chemistries for different assembly routes. Product differentiation is increasingly shifting beyond simple heat resistance toward precise peel-force control, low outgassing, low contamination, reduced leadframe warpage and reliable sealing against epoxy molding compound. Wah Hong's QFN tape product family uses polyimide substrates with controlled silicone adhesive thickness and several peel-strength grades, while Tapex positions its QFN masking tape around EMC no-leakage performance, wetting and removal on copper leadframes and pre-plated frames, wire-bonding stability and silicone-outgassing control. Demand is also broadening beyond conventional QFN toward DFN, SON, mini-QFN and leadless power packages, while copper wire, copper clip and higher-temperature assembly processes increase requirements for tape dimensional stability and adhesion consistency.

+357 96 030922
info@marketpublishers.com

Market Dynamics

Drivers

Growth in QFN, DFN and related leadless semiconductor packages is the primary structural driver of QFN Leadframe Backside Tape demand. These packages are widely used in analog ICs, power-management devices, microcontrollers, RF devices, sensors, automotive electronics and industrial semiconductors because they provide compact dimensions, short electrical paths, exposed thermal pads and relatively cost-efficient leadframe-based manufacturing. Map molding of multiple units on a common leadframe requires temporary backside sealing to prevent epoxy molding compound from flowing through exposed leadframe openings and contaminating terminals, making backside tape an important consumable in many QFN assembly flows. Increasing copper-wire bonding, automotive-grade qualification, miniaturized leadless packages and higher molding-process temperatures further raise performance requirements for high-temperature tape. DSK explicitly identifies leadframe backside tape as a supporting tape for QFN map molding that prevents flash burr and leaves no residue after peeling, while Solar Plus specifies its polyimide QFN tape for preventing epoxy bleeding at temperatures up to 260°C.

Restraints

The market is constrained by the highly specialized and relatively low-area-consumption nature of QFN backside tape compared with broader semiconductor tapes such as wafer dicing, backgrinding and protection films. Tape consumption depends on leadframe strip area rather than total semiconductor package revenue, so continuous package miniaturization and improved strip layout can reduce material usage per packaged device. Semiconductor assemblers also impose strict qualification requirements for ionic cleanliness, outgassing, residue, peel stability, plasma compatibility and high-temperature dimensional behavior, creating lengthy approval cycles for new suppliers. Differences among copper, silver-plated and other leadframe surfaces, molding compounds and wire-bonding temperatures limit the ability to standardize a single tape formulation across all customers. Price pressure from outsourced semiconductor assembly and test providers and leadframe manufacturers further limits margin expansion despite the material's high technical requirements.

Opportunities

+357 96 030922
info@marketpublishers.com

The most important opportunities lie in advanced adhesive formulations and locally qualified semiconductor material supply. Acrylic systems with reduced silicone contamination, hybrid adhesives with optimized high-temperature bonding and release behavior, low-outgassing formulations and antistatic tape structures can address increasingly demanding semiconductor assembly conditions. The rise of automotive, power-management and industrial IC production creates additional demand for tapes capable of maintaining stable adhesion through longer thermal exposure and higher process temperatures. There is also an opportunity for suppliers to provide multiple peel-force grades, customized widths, slit rolls and leadframe-specific lamination solutions rather than commodity master rolls. Wah Hong already offers several QFN tape grades with different peel strengths on a common polyimide-silicone platform, while Solar Plus markets customized QFN tape solutions for semiconductor customers. China represents an additional localization opportunity as domestic semiconductor packaging and leadframe industries seek alternatives to imported Japanese, Korean and Taiwanese process materials.

Challenges

The principal technical challenge is balancing sufficient adhesion during die bonding, wire bonding, plasma cleaning and molding with clean removal after high-temperature exposure. Excessive adhesion can leave residue or damage leadframe surfaces, while insufficient adhesion can allow molding compound leakage, tape lifting or package defects. The tape must also maintain dimensional stability across repeated thermal cycles without excessive shrinkage or warpage, while avoiding silicone migration, volatile contamination and ionic impurities that can reduce semiconductor reliability. Very thin adhesive layers must be coated with tight thickness tolerances, making roll-to-roll coating control and cleanroom processing important competitive capabilities. Semiconductor customers also require lot-to-lot consistency and long qualification histories, so new suppliers face significant barriers in achieving automotive and high-reliability package approval even when laboratory performance is comparable with established products.

Industry Chain Analysis

The upstream of the QFN Leadframe Backside Tape industry includes polyimide, polyester and fluoropolymer films, silicone and acrylic pressure-sensitive adhesive raw materials, epoxy and phenoxy modifiers, release liners, antistatic additives, solvents,

+357 96 030922
info@marketpublishers.com

primers and specialty coating chemicals, together with precision coating, drying, laminating, slitting and cleanroom converting equipment. Midstream manufacturers formulate semiconductor-grade adhesives, coat and cure thin adhesive layers on heat-resistant films, laminate release liners where required, control surface cleanliness and thickness, slit rolls to customer specification and perform high-temperature adhesion, peel, contamination and residue testing. The product is then supplied either directly to semiconductor assembly houses and leadframe manufacturers or through specialized semiconductor material channels. Wah Hong identifies QFN tape as a semiconductor-process precision coating product and specifies a 25 ?m polyimide substrate combined with a 10 ?m silicone adhesive layer for its PCT035QI series. Downstream users include leadframe manufacturers, outsourced semiconductor assembly and test companies, integrated device manufacturers and specialized packaging plants. Value creation is concentrated in adhesive formulation, high-uniformity coating, contamination control, reliable high-temperature performance, customer-specific peel-force optimization and semiconductor-grade qualification.

Segment Insights

By adhesive type, silicone adhesives form a major commercial category because of their excellent high-temperature stability, consistent release behavior and compatibility with polyimide substrates. Acrylic adhesives provide an important alternative where reduced silicone transfer and different surface-wetting characteristics are required, while epoxy-modified and hybrid systems are used to tune adhesion, heat resistance and post-molding release characteristics. Koan Hao commercially offers both acrylic and silicone PSA QFN tapes, with acrylic products positioned for plasma-cleaning compatibility and avoidance of silicone precipitation issues, while its silicone products emphasize stability and residue-free removal during QFN molding.

By substrate film, polyimide is the dominant material because it combines dimensional stability, dielectric performance and resistance to QFN process temperatures. Polyester, fluoropolymer and composite films occupy more specialized applications where cost, release performance or specific process windows justify alternative substrates. Heat resistance is another important technical segmentation dimension. Products below 200°C can serve lower-temperature processes, while the 200–230°C and 230–260°C ranges cover a large share of mainstream and advanced QFN assembly requirements. Products capable of maintaining performance above 260°C represent a more demanding specialty segment. Koan Hao and Solar Plus both specify QFN tape solutions capable of withstanding up to approximately 260°C, whereas Wah Hong specifies 200°C performance for its PCT035QI series.

+357 96 030922
info@marketpublishers.com

Downstream Market Opportunities

QFN packaging represents the largest downstream application because map-molded QFN structures frequently require temporary backside sealing to prevent molding compound from leaking through exposed terminal areas. DFN uses a similar leadless leadframe architecture and forms the second major application opportunity, particularly in compact analog, power-management and discrete semiconductor devices. SON and mini-QFN packages extend demand into smaller package dimensions and finer-pitch applications, while leadless power packages create opportunities where exposed thermal pads, higher molding temperatures and demanding reliability requirements increase the value of stable backside protection materials. Future growth will be strongest in applications combining high-volume semiconductor output with tighter package geometries, automotive qualification and higher-temperature assembly conditions rather than in mature low-value consumer packages alone.

Regional Insights

East Asia is the core production and consumption region for QFN Leadframe Backside Tape because it contains a dense concentration of semiconductor packaging, leadframe production and precision adhesive-material suppliers. Japan maintains strong technical capability through companies such as TOMOEGAWA and Resonac, particularly in high-reliability semiconductor process materials. South Korea is another important supply center, represented by INNOX Advanced Materials, Tapex, EPSOL and Daehyun ST, while Taiwan has a broad specialist coating and converting base including Koan Hao Technology, Wah Hong Industrial and Solar Plus. Koan Hao explicitly manufactures QFN tapes for preventing epoxy overflow during leadframe molding, and Wah Hong lists QFN tape among its semiconductor-process precision coating products.

China is developing a growing domestic supply base alongside expansion in semiconductor assembly, leadframe and power-device production, with companies such as Guangdong Maosen Chip Materials entering specialized QFN tape materials. Southeast Asia remains important on the demand and supply-service side because Singapore, Malaysia, the Philippines and Thailand host major semiconductor packaging operations. DSK Technologies in Singapore, for example, provides leadframe backside tape specifically for QFN molding and operates across several Southeast Asian markets. North America contributes through global material suppliers such as 3M and through demand from automotive, analog and power semiconductor packaging, but the

+357 96 030922
info@marketpublishers.com

highest concentration of dedicated QFN tape manufacturing remains in Asia.

Competitive Landscape Analysis

The QFN Leadframe Backside Tape market is relatively specialized and fragmented across global adhesive-material groups and regional semiconductor tape specialists. TOMOEGAWA and Resonac represent established Japanese semiconductor process-material suppliers, while 3M participates through heat-resistant polyimide masking technologies. South Korean suppliers including INNOX Advanced Materials and Tapex compete through dedicated semiconductor material portfolios and customized QFN masking solutions; INNOX explicitly lists QFN Tape as part of its semiconductor packaging materials business, while Tapex emphasizes EMC leakage prevention, leadframe wetting and wire-bonding stability. Taiwan has a particularly dense specialist supplier base, with Koan Hao, Wah Hong and Solar Plus competing through flexible adhesive formulations, multiple peel-force grades, customized coating and converting capabilities. Singapore-based DSK and other specialist suppliers extend regional availability. Competition is therefore determined less by simple tape price than by high-temperature stability, molding-compound sealing performance, residue control, outgassing, ionic cleanliness, leadframe compatibility, coating consistency and the ability to pass long semiconductor customer qualification cycles.

Report Scope

This report studies the global QFN Leadframe Backside Tape production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for QFN Leadframe Backside Tape and provides market size (US$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of QFN Leadframe Backside Tape that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global QFN Leadframe Backside Tape total production and demand, 2021-2032, (K Sqm)

+357 96 030922
info@marketpublishers.com

Global QFN Leadframe Backside Tape total production value, 2021-2032, (USD Million)

Global QFN Leadframe Backside Tape production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm), (based on production site)

Global QFN Leadframe Backside Tape consumption by region & country, CAGR, 2021-2032 & (K Sqm)

U.S. VS China: QFN Leadframe Backside Tape domestic production, consumption, key domestic manufacturers and share

Global QFN Leadframe Backside Tape production by manufacturer, production, price, value and market share 2021-2026, (USD Million) & (K Sqm)

Global QFN Leadframe Backside Tape production by Adhesive Type, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm)

Global QFN Leadframe Backside Tape production by Application, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm)

This report profiles key players in the global QFN Leadframe Backside Tape market based on the following parameters - company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include 3M, Daehyun ST, Resonac, Koan Hao Technology, TOMOEGAWA Corporation, DSK Technologies, SKYMART Technologies, Solar Plus Company, INNOX Advanced Materials, Wah Hong Industrial Corporation, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World QFN Leadframe Backside Tape market

+357 96 030922
info@marketpublishers.com

Detailed Segmentation:

Each section contains quantitative market data including market by value (US$ Millions), volume (production, consumption) & (K Sqm) and average price (US$/Sq m) by manufacturer, by Adhesive Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

Global QFN Leadframe Backside Tape Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

Market Segmentation

Global QFN Leadframe Backside Tape Market, Segmentation by Adhesive Type:

Silicone Adhesive

Acrylic Adhesive

Epoxy-modified Adhesive

+357 96 030922
info@marketpublishers.com

Hybrid Adhesive

Others

Global QFN Leadframe Backside Tape Market, Segmentation by Base Film:

Polyimide Film

Polyester Film

Fluoropolymer Film

Composite Film

Others

Global QFN Leadframe Backside Tape Market, Segmentation by Heat Resistance:

Below 200°C

200–230°C

230–260°C

Above 260°C

Global QFN Leadframe Backside Tape Market, Segmentation by Application:

QFN Packaging

DFN Packaging

+357 96 030922
info@marketpublishers.com

SON Packaging

Mini-QFN Packaging

Leadless Power Package

Others

Companies Profiled:

3M

Daehyun ST

Resonac

Koan Hao Technology

TOMOEGAWA Corporation

DSK Technologies

SKYMART Technologies

Solar Plus Company

INNOX Advanced Materials

Wah Hong Industrial Corporation

Toyo Adtec

Guangdong Maosen Chip Materials Co., Ltd.

Tapex Co., Ltd.

+357 96 030922
info@marketpublishers.com

EPSOL Co., Ltd.

Key Questions Answered

1. How big is the global QFN Leadframe Backside Tape market?
2. What is the demand of the global QFN Leadframe Backside Tape market?
3. What is the year over year growth of the global QFN Leadframe Backside Tape market?
4. What is the total value of the global QFN Leadframe Backside Tape market?
5. Who are the Major Players in the global QFN Leadframe Backside Tape market?
6. What are the growth factors driving the market demand?

+357 96 030922
info@marketpublishers.com

Contents

1 SUPPLY SUMMARY

1.1 QFN Leadframe Backside Tape Introduction
1.2 World QFN Leadframe Backside Tape Supply & Forecast
  1.2.1 World QFN Leadframe Backside Tape Production Value (2021 & 2025 & 2032)
  1.2.2 World QFN Leadframe Backside Tape Production (2021-2032)
  1.2.3 World QFN Leadframe Backside Tape Pricing Trends (2021-2032)
1.3 World QFN Leadframe Backside Tape Production by Region (Based on Production Site)
  1.3.1 World QFN Leadframe Backside Tape Production Value by Region (2021-2032)
  1.3.2 World QFN Leadframe Backside Tape Production by Region (2021-2032)
  1.3.3 World QFN Leadframe Backside Tape Average Price by Region (2021-2032)
  1.3.4 North America QFN Leadframe Backside Tape Production (2021-2032)
  1.3.5 Europe QFN Leadframe Backside Tape Production (2021-2032)
  1.3.6 China QFN Leadframe Backside Tape Production (2021-2032)
  1.3.7 Japan QFN Leadframe Backside Tape Production (2021-2032)
  1.3.8 South Korea QFN Leadframe Backside Tape Production (2021-2032)
1.4 Market Drivers, Restraints and Trends
  1.4.1 QFN Leadframe Backside Tape Market Drivers
  1.4.2 Factors Affecting Demand
  1.4.3 QFN Leadframe Backside Tape Major Market Trends

2 DEMAND SUMMARY

2.1 World QFN Leadframe Backside Tape Demand (2021-2032)
2.2 World QFN Leadframe Backside Tape Consumption by Region
  2.2.1 World QFN Leadframe Backside Tape Consumption by Region (2021-2026)
  2.2.2 World QFN Leadframe Backside Tape Consumption Forecast by Region (2027-2032)
2.3 United States QFN Leadframe Backside Tape Consumption (2021-2032)
2.4 China QFN Leadframe Backside Tape Consumption (2021-2032)
2.5 Europe QFN Leadframe Backside Tape Consumption (2021-2032)
2.6 Japan QFN Leadframe Backside Tape Consumption (2021-2032)
2.7 South Korea QFN Leadframe Backside Tape Consumption (2021-2032)
2.8 ASEAN QFN Leadframe Backside Tape Consumption (2021-2032)
2.9 India QFN Leadframe Backside Tape Consumption (2021-2032)

+357 96 030922
info@marketpublishers.com

3 WORLD MANUFACTURERS COMPETITIVE ANALYSIS

3.1 World QFN Leadframe Backside Tape Production Value by Manufacturer (2021-2026)
3.2 World QFN Leadframe Backside Tape Production by Manufacturer (2021-2026)
3.3 World QFN Leadframe Backside Tape Average Price by Manufacturer (2021-2026)
3.4 QFN Leadframe Backside Tape Company Evaluation Quadrant
3.5 Industry Rank and Concentration Rate (CR)
  3.5.1 Global QFN Leadframe Backside Tape Industry Rank of Major Manufacturers
  3.5.2 Global Concentration Ratios (CR4) for QFN Leadframe Backside Tape in 2025
  3.5.3 Global Concentration Ratios (CR8) for QFN Leadframe Backside Tape in 2025
3.6 QFN Leadframe Backside Tape Market: Overall Company Footprint Analysis
  3.6.1 QFN Leadframe Backside Tape Market: Region Footprint
  3.6.2 QFN Leadframe Backside Tape Market: Company Product Type Footprint
  3.6.3 QFN Leadframe Backside Tape Market: Company Product Application Footprint
3.7 Competitive Environment
  3.7.1 Historical Structure of the Industry
  3.7.2 Barriers of Market Entry
  3.7.3 Factors of Competition
3.8 New Entrant and Capacity Expansion Plans
3.9 Mergers, Acquisition, Agreements, and Collaborations

4 UNITED STATES VS CHINA VS REST OF THE WORLD

4.1 United States VS China: QFN Leadframe Backside Tape Production Value Comparison
  4.1.1 United States VS China: QFN Leadframe Backside Tape Production Value Comparison (2021 & 2025 & 2032)
  4.1.2 United States VS China: QFN Leadframe Backside Tape Production Value Market Share Comparison (2021 & 2025 & 2032)
4.2 United States VS China: QFN Leadframe Backside Tape Production Comparison
  4.2.1 United States VS China: QFN Leadframe Backside Tape Production Comparison (2021 & 2025 & 2032)
  4.2.2 United States VS China: QFN Leadframe Backside Tape Production Market Share Comparison (2021 & 2025 & 2032)
4.3 United States VS China: QFN Leadframe Backside Tape Consumption Comparison
  4.3.1 United States VS China: QFN Leadframe Backside Tape Consumption Comparison (2021 & 2025 & 2032)
  4.3.2 United States VS China: QFN Leadframe Backside Tape Consumption Market

+357 96 030922
info@marketpublishers.com

Share Comparison (2021 & 2025 & 2032)
4.4 United States Based QFN Leadframe Backside Tape Manufacturers and Market Share, 2021-2026
4.4.1 United States Based QFN Leadframe Backside Tape Manufacturers, Headquarters and Production Site (States, Country)
4.4.2 United States Based Manufacturers QFN Leadframe Backside Tape Production Value (2021-2026)
4.4.3 United States Based Manufacturers QFN Leadframe Backside Tape Production (2021-2026)
4.5 China Based QFN Leadframe Backside Tape Manufacturers and Market Share
4.5.1 China Based QFN Leadframe Backside Tape Manufacturers, Headquarters and Production Site (Province, Country)
4.5.2 China Based Manufacturers QFN Leadframe Backside Tape Production Value (2021-2026)
4.5.3 China Based Manufacturers QFN Leadframe Backside Tape Production (2021-2026)
4.6 Rest of World Based QFN Leadframe Backside Tape Manufacturers and Market Share, 2021-2026
4.6.1 Rest of World Based QFN Leadframe Backside Tape Manufacturers, Headquarters and Production Site (State, Country)
4.6.2 Rest of World Based Manufacturers QFN Leadframe Backside Tape Production Value (2021-2026)
4.6.3 Rest of World Based Manufacturers QFN Leadframe Backside Tape Production (2021-2026)

5 MARKET ANALYSIS BY ADHESIVE TYPE

5.1 World QFN Leadframe Backside Tape Market Size Overview by Adhesive Type: 2021 VS 2025 VS 2032
5.2 Segment Introduction by Adhesive Type
5.2.1 Silicone Adhesive
5.2.2 Acrylic Adhesive
5.2.3 Epoxy-modified Adhesive
5.2.4 Hybrid Adhesive
5.2.5 Others
5.3 Market Segment by Adhesive Type
5.3.1 World QFN Leadframe Backside Tape Production by Adhesive Type (2021-2032)
5.3.2 World QFN Leadframe Backside Tape Production Value by Adhesive Type

+357 96 030922
info@marketpublishers.com

(2021-2032)
5.3.3 World QFN Leadframe Backside Tape Average Price by Adhesive Type (2021-2032)

6 MARKET ANALYSIS BY BASE FILM

6.1 World QFN Leadframe Backside Tape Market Size Overview by Base Film: 2021 VS 2025 VS 2032
6.2 Segment Introduction by Base Film
6.2.1 Polyimide Film
6.2.2 Polyester Film
6.2.3 Fluoropolymer Film
6.2.4 Composite Film
6.2.5 Others
6.3 Market Segment by Base Film
6.3.1 World QFN Leadframe Backside Tape Production by Base Film (2021-2032)
6.3.2 World QFN Leadframe Backside Tape Production Value by Base Film (2021-2032)
6.3.3 World QFN Leadframe Backside Tape Average Price by Base Film (2021-2032)

7 MARKET ANALYSIS BY HEAT RESISTANCE

7.1 World QFN Leadframe Backside Tape Market Size Overview by Heat Resistance: 2021 VS 2025 VS 2032
7.2 Segment Introduction by Heat Resistance
7.2.1 Below 200°C
7.2.2 200–230°C
7.2.3 230–260°C
7.2.4 Above 260°C
7.3 Market Segment by Heat Resistance
7.3.1 World QFN Leadframe Backside Tape Production by Heat Resistance (2021-2032)
7.3.2 World QFN Leadframe Backside Tape Production Value by Heat Resistance (2021-2032)
7.3.3 World QFN Leadframe Backside Tape Average Price by Heat Resistance (2021-2032)

8 MARKET ANALYSIS BY APPLICATION

+357 96 030922
info@marketpublishers.com

8.1 World QFN Leadframe Backside Tape Market Size Overview by Application: 2021 VS 2025 VS 2032
8.2 Segment Introduction by Application
8.2.1 QFN Packaging
8.2.2 DFN Packaging
8.2.3 SON Packaging
8.2.4 Mini-QFN Packaging
8.2.5 Leadless Power Package
8.2.6 Others
8.3 Market Segment by Application
8.3.1 World QFN Leadframe Backside Tape Production by Application (2021-2032)
8.3.2 World QFN Leadframe Backside Tape Production Value by Application (2021-2032)
8.3.3 World QFN Leadframe Backside Tape Average Price by Application (2021-2032)

9 COMPANY PROFILES

9.1 3M
9.1.1 3M Details
9.1.2 3M Major Business
9.1.3 3M QFN Leadframe Backside Tape Product and Services
9.1.4 3M QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.1.5 3M Recent Developments/Updates
9.1.6 3M Competitive Strengths & Weaknesses
9.2 Daehyun ST
9.2.1 Daehyun ST Details
9.2.2 Daehyun ST Major Business
9.2.3 Daehyun ST QFN Leadframe Backside Tape Product and Services
9.2.4 Daehyun ST QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.2.5 Daehyun ST Recent Developments/Updates
9.2.6 Daehyun ST Competitive Strengths & Weaknesses
9.3 Resonac
9.3.1 Resonac Details
9.3.2 Resonac Major Business
9.3.3 Resonac QFN Leadframe Backside Tape Product and Services
9.3.4 Resonac QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)

+357 96 030922
info@marketpublishers.com

9.3.5 Resonac Recent Developments/Updates
9.3.6 Resonac Competitive Strengths & Weaknesses
9.4 Koan Hao Technology
9.4.1 Koan Hao Technology Details
9.4.2 Koan Hao Technology Major Business
9.4.3 Koan Hao Technology QFN Leadframe Backside Tape Product and Services
9.4.4 Koan Hao Technology QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.4.5 Koan Hao Technology Recent Developments/Updates
9.4.6 Koan Hao Technology Competitive Strengths & Weaknesses
9.5 TOMOEGAWA Corporation
9.5.1 TOMOEGAWA Corporation Details
9.5.2 TOMOEGAWA Corporation Major Business
9.5.3 TOMOEGAWA Corporation QFN Leadframe Backside Tape Product and Services
9.5.4 TOMOEGAWA Corporation QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.5.5 TOMOEGAWA Corporation Recent Developments/Updates
9.5.6 TOMOEGAWA Corporation Competitive Strengths & Weaknesses
9.6 DSK Technologies
9.6.1 DSK Technologies Details
9.6.2 DSK Technologies Major Business
9.6.3 DSK Technologies QFN Leadframe Backside Tape Product and Services
9.6.4 DSK Technologies QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.6.5 DSK Technologies Recent Developments/Updates
9.6.6 DSK Technologies Competitive Strengths & Weaknesses
9.7 SKYMART Technologies
9.7.1 SKYMART Technologies Details
9.7.2 SKYMART Technologies Major Business
9.7.3 SKYMART Technologies QFN Leadframe Backside Tape Product and Services
9.7.4 SKYMART Technologies QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.7.5 SKYMART Technologies Recent Developments/Updates
9.7.6 SKYMART Technologies Competitive Strengths & Weaknesses
9.8 Solar Plus Company
9.8.1 Solar Plus Company Details
9.8.2 Solar Plus Company Major Business
9.8.3 Solar Plus Company QFN Leadframe Backside Tape Product and Services

+357 96 030922
info@marketpublishers.com

9.8.4 Solar Plus Company QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.8.5 Solar Plus Company Recent Developments/Updates
9.8.6 Solar Plus Company Competitive Strengths & Weaknesses
9.9 INNOX Advanced Materials
9.9.1 INNOX Advanced Materials Details
9.9.2 INNOX Advanced Materials Major Business
9.9.3 INNOX Advanced Materials QFN Leadframe Backside Tape Product and Services
9.9.4 INNOX Advanced Materials QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.9.5 INNOX Advanced Materials Recent Developments/Updates
9.9.6 INNOX Advanced Materials Competitive Strengths & Weaknesses
9.10 Wah Hong Industrial Corporation
9.10.1 Wah Hong Industrial Corporation Details
9.10.2 Wah Hong Industrial Corporation Major Business
9.10.3 Wah Hong Industrial Corporation QFN Leadframe Backside Tape Product and Services
9.10.4 Wah Hong Industrial Corporation QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.10.5 Wah Hong Industrial Corporation Recent Developments/Updates
9.10.6 Wah Hong Industrial Corporation Competitive Strengths & Weaknesses
9.11 Toyo Adtec
9.11.1 Toyo Adtec Details
9.11.2 Toyo Adtec Major Business
9.11.3 Toyo Adtec QFN Leadframe Backside Tape Product and Services
9.11.4 Toyo Adtec QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.11.5 Toyo Adtec Recent Developments/Updates
9.11.6 Toyo Adtec Competitive Strengths & Weaknesses
9.12 Guangdong Maosen Chip Materials Co., Ltd.
9.12.1 Guangdong Maosen Chip Materials Co., Ltd. Details
9.12.2 Guangdong Maosen Chip Materials Co., Ltd. Major Business
9.12.3 Guangdong Maosen Chip Materials Co., Ltd. QFN Leadframe Backside Tape Product and Services
9.12.4 Guangdong Maosen Chip Materials Co., Ltd. QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.12.5 Guangdong Maosen Chip Materials Co., Ltd. Recent Developments/Updates
9.12.6 Guangdong Maosen Chip Materials Co., Ltd. Competitive Strengths &

+357 96 030922
info@marketpublishers.com

Weaknesses
9.13 Tapex Co., Ltd.
9.13.1 Tapex Co., Ltd. Details
9.13.2 Tapex Co., Ltd. Major Business
9.13.3 Tapex Co., Ltd. QFN Leadframe Backside Tape Product and Services
9.13.4 Tapex Co., Ltd. QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.13.5 Tapex Co., Ltd. Recent Developments/Updates
9.13.6 Tapex Co., Ltd. Competitive Strengths & Weaknesses
9.14 EPSOL Co., Ltd.
9.14.1 EPSOL Co., Ltd. Details
9.14.2 EPSOL Co., Ltd. Major Business
9.14.3 EPSOL Co., Ltd. QFN Leadframe Backside Tape Product and Services
9.14.4 EPSOL Co., Ltd. QFN Leadframe Backside Tape Production, Price, Value, Gross Margin and Market Share (2021-2026)
9.14.5 EPSOL Co., Ltd. Recent Developments/Updates
9.14.6 EPSOL Co., Ltd. Competitive Strengths & Weaknesses

10 INDUSTRY CHAIN ANALYSIS

10.1 QFN Leadframe Backside Tape Industry Chain
10.2 QFN Leadframe Backside Tape Upstream Analysis
10.2.1 QFN Leadframe Backside Tape Core Raw Materials
10.2.2 Main Manufacturers of QFN Leadframe Backside Tape Core Raw Materials
10.3 Midstream Analysis
10.4 Downstream Analysis
10.5 QFN Leadframe Backside Tape Production Mode
10.6 QFN Leadframe Backside Tape Procurement Model
10.7 QFN Leadframe Backside Tape Industry Sales Model and Sales Channels
10.7.1 QFN Leadframe Backside Tape Sales Model
10.7.2 QFN Leadframe Backside Tape Typical Distributors

11 RESEARCH FINDINGS AND CONCLUSION

12 APPENDIX

12.1 Methodology
12.2 Research Process and Data Source
12.3 Disclaimer

+357 96 030922
info@marketpublishers.com

List Of Tables

LIST OF TABLES

Table 1. World QFN Leadframe Backside Tape Production Value by Region (2021, 2025 and 2032) & (USD Million)
Table 2. World QFN Leadframe Backside Tape Production Value by Region (2021-2026) & (USD Million)
Table 3. World QFN Leadframe Backside Tape Production Value by Region (2027-2032) & (USD Million)
Table 4. World QFN Leadframe Backside Tape Production Value Market Share by Region (2021-2026)
Table 5. World QFN Leadframe Backside Tape Production Value Market Share by Region (2027-2032)
Table 6. World QFN Leadframe Backside Tape Production by Region (2021-2026) & (K Sqm)
Table 7. World QFN Leadframe Backside Tape Production by Region (2027-2032) & (K Sqm)
Table 8. World QFN Leadframe Backside Tape Production Market Share by Region (2021-2026)
Table 9. World QFN Leadframe Backside Tape Production Market Share by Region (2027-2032)
Table 10. World QFN Leadframe Backside Tape Average Price by Region (2021-2026) & (US$/Sq m)
Table 11. World QFN Leadframe Backside Tape Average Price by Region (2027-2032) & (US$/Sq m)
Table 12. QFN Leadframe Backside Tape Major Market Trends
Table 13. World QFN Leadframe Backside Tape Consumption Growth Rate Forecast by Region (2021 & 2025 & 2032) & (K Sqm)
Table 14. World QFN Leadframe Backside Tape Consumption by Region (2021-2026) & (K Sqm)
Table 15. World QFN Leadframe Backside Tape Consumption Forecast by Region (2027-2032) & (K Sqm)
Table 16. World QFN Leadframe Backside Tape Production Value by Manufacturer (2021-2026) & (USD Million)
Table 17. Production Value Market Share of Key QFN Leadframe Backside Tape Producers in 2025
Table 18. World QFN Leadframe Backside Tape Production by Manufacturer (2021-2026) & (K Sqm)

+357 96 030922
info@marketpublishers.com

Table 19. Production Market Share of Key QFN Leadframe Backside Tape Producers in 2025
Table 20. World QFN Leadframe Backside Tape Average Price by Manufacturer (2021-2026) & (US$/Sq m)
Table 21. Global QFN Leadframe Backside Tape Company Evaluation Quadrant
Table 22. World QFN Leadframe Backside Tape Industry Rank of Major Manufacturers, Based on Production Value in 2025
Table 23. Head Office and QFN Leadframe Backside Tape Production Site of Key Manufacturer
Table 24. QFN Leadframe Backside Tape Market: Company Product Type Footprint
Table 25. QFN Leadframe Backside Tape Market: Company Product Application Footprint
Table 26. QFN Leadframe Backside Tape Competitive Factors
Table 27. QFN Leadframe Backside Tape New Entrant and Capacity Expansion Plans
Table 28. QFN Leadframe Backside Tape Mergers & Acquisitions Activity
Table 29. United States VS China QFN Leadframe Backside Tape Production Value Comparison, (2021 & 2025 & 2032) & (USD Million)
Table 30. United States VS China QFN Leadframe Backside Tape Production Comparison, (2021 & 2025 & 2032) & (K Sqm)
Table 31. United States VS China QFN Leadframe Backside Tape Consumption Comparison, (2021 & 2025 & 2032) & (K Sqm)
Table 32. United States Based QFN Leadframe Backside Tape Manufacturers, Headquarters and Production Site (States, Country)
Table 33. United States Based Manufacturers QFN Leadframe Backside Tape Production Value, (2021-2026) & (USD Million)
Table 34. United States Based Manufacturers QFN Leadframe Backside Tape Production Value Market Share (2021-2026)
Table 35. United States Based Manufacturers QFN Leadframe Backside Tape Production (2021-2026) & (K Sqm)
Table 36. United States Based Manufacturers QFN Leadframe Backside Tape Production Market Share (2021-2026)
Table 37. China Based QFN Leadframe Backside Tape Manufacturers, Headquarters and Production Site (Province, Country)
Table 38. China Based Manufacturers QFN Leadframe Backside Tape Production Value, (2021-2026) & (USD Million)
Table 39. China Based Manufacturers QFN Leadframe Backside Tape Production Value Market Share (2021-2026)
Table 40. China Based Manufacturers QFN Leadframe Backside Tape Production, (2021-2026) & (K Sqm)

+357 96 030922
info@marketpublishers.com

Table 41. China Based Manufacturers QFN Leadframe Backside Tape Production Market Share (2021-2026)
Table 42. Rest of World Based QFN Leadframe Backside Tape Manufacturers, Headquarters and Production Site (State, Country)
Table 43. Rest of World Based Manufacturers QFN Leadframe Backside Tape Production Value, (2021-2026) & (USD Million)
Table 44. Rest of World Based Manufacturers QFN Leadframe Backside Tape Production Value Market Share (2021-2026)
Table 45. Rest of World Based Manufacturers QFN Leadframe Backside Tape Production, (2021-2026) & (K Sqm)
Table 46. Rest of World Based Manufacturers QFN Leadframe Backside Tape Production Market Share (2021-2026)
Table 47. World QFN Leadframe Backside Tape Production Value by Adhesive Type, (USD Million), 2021 & 2025 & 2032
Table 48. World QFN Leadframe Backside Tape Production by Adhesive Type (2021-2026) & (K Sqm)
Table 49. World QFN Leadframe Backside Tape Production by Adhesive Type (2027-2032) & (K Sqm)
Table 50. World QFN Leadframe Backside Tape Production Value by Adhesive Type (2021-2026) & (USD Million)
Table 51. World QFN Leadframe Backside Tape Production Value by Adhesive Type (2027-2032) & (USD Million)
Table 52. World QFN Leadframe Backside Tape Average Price by Adhesive Type (2021-2026) & (US$/Sq m)
Table 53. World QFN Leadframe Backside Tape Average Price by Adhesive Type (2027-2032) & (US$/Sq m)
Table 54. World QFN Leadframe Backside Tape Production Value by Base Film, (USD Million), 2021 & 2025 & 2032
Table 55. World QFN Leadframe Backside Tape Production by Base Film (2021-2026) & (K Sqm)
Table 56. World QFN Leadframe Backside Tape Production by Base Film (2027-2032) & (K Sqm)
Table 57. World QFN Leadframe Backside Tape Production Value by Base Film (2021-2026) & (USD Million)
Table 58. World QFN Leadframe Backside Tape Production Value by Base Film (2027-2032) & (USD Million)
Table 59. World QFN Leadframe Backside Tape Average Price by Base Film (2021-2026) & (US$/Sq m)
Table 60. World QFN Leadframe Backside Tape Average Price by Base Film

+357 96 030922
info@marketpublishers.com

(2027-2032) & (US$/Sq m)
Table 61. World QFN Leadframe Backside Tape Production Value by Heat Resistance, (USD Million), 2021 & 2025 & 2032
Table 62. World QFN Leadframe Backside Tape Production by Heat Resistance (2021-2026) & (K Sqm)
Table 63. World QFN Leadframe Backside Tape Production by Heat Resistance (2027-2032) & (K Sqm)
Table 64. World QFN Leadframe Backside Tape Production Value by Heat Resistance (2021-2026) & (USD Million)
Table 65. World QFN Leadframe Backside Tape Production Value by Heat Resistance (2027-2032) & (USD Million)
Table 66. World QFN Leadframe Backside Tape Average Price by Heat Resistance (2021-2026) & (US$/Sq m)
Table 67. World QFN Leadframe Backside Tape Average Price by Heat Resistance (2027-2032) & (US$/Sq m)
Table 68. World QFN Leadframe Backside Tape Production Value by Application, (USD Million), 2021 & 2025 & 2032
Table 69. World QFN Leadframe Backside Tape Production by Application (2021-2026) & (K Sqm)
Table 70. World QFN Leadframe Backside Tape Production by Application (2027-2032) & (K Sqm)
Table 71. World QFN Leadframe Backside Tape Production Value by Application (2021-2026) & (USD Million)
Table 72. World QFN Leadframe Backside Tape Production Value by Application (2027-2032) & (USD Million)
Table 73. World QFN Leadframe Backside Tape Average Price by Application (2021-2026) & (US$/Sq m)
Table 74. World QFN Leadframe Backside Tape Average Price by Application (2027-2032) & (US$/Sq m)
Table 75. 3M Basic Information, Manufacturing Base and Competitors
Table 76. 3M Major Business
Table 77. 3M QFN Leadframe Backside Tape Product and Services
Table 78. 3M QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 79. 3M Recent Developments/Updates
Table 80. 3M Competitive Strengths & Weaknesses
Table 81. Daehyun ST Basic Information, Manufacturing Base and Competitors
Table 82. Daehyun ST Major Business
Table 83. Daehyun ST QFN Leadframe Backside Tape Product and Services

+357 96 030922
info@marketpublishers.com

Table 84. Daehyun ST QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 85. Daehyun ST Recent Developments/Updates
Table 86. Daehyun ST Competitive Strengths & Weaknesses
Table 87. Resonac Basic Information, Manufacturing Base and Competitors
Table 88. Resonac Major Business
Table 89. Resonac QFN Leadframe Backside Tape Product and Services
Table 90. Resonac QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 91. Resonac Recent Developments/Updates
Table 92. Resonac Competitive Strengths & Weaknesses
Table 93. Koan Hao Technology Basic Information, Manufacturing Base and Competitors
Table 94. Koan Hao Technology Major Business
Table 95. Koan Hao Technology QFN Leadframe Backside Tape Product and Services
Table 96. Koan Hao Technology QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 97. Koan Hao Technology Recent Developments/Updates
Table 98. Koan Hao Technology Competitive Strengths & Weaknesses
Table 99. TOMOEGAWA Corporation Basic Information, Manufacturing Base and Competitors
Table 100. TOMOEGAWA Corporation Major Business
Table 101. TOMOEGAWA Corporation QFN Leadframe Backside Tape Product and Services
Table 102. TOMOEGAWA Corporation QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 103. TOMOEGAWA Corporation Recent Developments/Updates
Table 104. TOMOEGAWA Corporation Competitive Strengths & Weaknesses
Table 105. DSK Technologies Basic Information, Manufacturing Base and Competitors
Table 106. DSK Technologies Major Business
Table 107. DSK Technologies QFN Leadframe Backside Tape Product and Services
Table 108. DSK Technologies QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 109. DSK Technologies Recent Developments/Updates
Table 110. DSK Technologies Competitive Strengths & Weaknesses

+357 96 030922
info@marketpublishers.com

Table 111. SKYMART Technologies Basic Information, Manufacturing Base and Competitors
Table 112. SKYMART Technologies Major Business
Table 113. SKYMART Technologies QFN Leadframe Backside Tape Product and Services
Table 114. SKYMART Technologies QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 115. SKYMART Technologies Recent Developments/Updates
Table 116. SKYMART Technologies Competitive Strengths & Weaknesses
Table 117. Solar Plus Company Basic Information, Manufacturing Base and Competitors
Table 118. Solar Plus Company Major Business
Table 119. Solar Plus Company QFN Leadframe Backside Tape Product and Services
Table 120. Solar Plus Company QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 121. Solar Plus Company Recent Developments/Updates
Table 122. Solar Plus Company Competitive Strengths & Weaknesses
Table 123. INNOX Advanced Materials Basic Information, Manufacturing Base and Competitors
Table 124. INNOX Advanced Materials Major Business
Table 125. INNOX Advanced Materials QFN Leadframe Backside Tape Product and Services
Table 126. INNOX Advanced Materials QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 127. INNOX Advanced Materials Recent Developments/Updates
Table 128. INNOX Advanced Materials Competitive Strengths & Weaknesses
Table 129. Wah Hong Industrial Corporation Basic Information, Manufacturing Base and Competitors
Table 130. Wah Hong Industrial Corporation Major Business
Table 131. Wah Hong Industrial Corporation QFN Leadframe Backside Tape Product and Services
Table 132. Wah Hong Industrial Corporation QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 133. Wah Hong Industrial Corporation Recent Developments/Updates
Table 134. Wah Hong Industrial Corporation Competitive Strengths & Weaknesses

+357 96 030922
info@marketpublishers.com

Table 135. Toyo Adtec Basic Information, Manufacturing Base and Competitors
Table 136. Toyo Adtec Major Business
Table 137. Toyo Adtec QFN Leadframe Backside Tape Product and Services
Table 138. Toyo Adtec QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 139. Toyo Adtec Recent Developments/Updates
Table 140. Toyo Adtec Competitive Strengths & Weaknesses
Table 141. Guangdong Maosen Chip Materials Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 142. Guangdong Maosen Chip Materials Co., Ltd. Major Business
Table 143. Guangdong Maosen Chip Materials Co., Ltd. QFN Leadframe Backside Tape Product and Services
Table 144. Guangdong Maosen Chip Materials Co., Ltd. QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 145. Guangdong Maosen Chip Materials Co., Ltd. Recent Developments/Updates
Table 146. Guangdong Maosen Chip Materials Co., Ltd. Competitive Strengths & Weaknesses
Table 147. Tapex Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 148. Tapex Co., Ltd. Major Business
Table 149. Tapex Co., Ltd. QFN Leadframe Backside Tape Product and Services
Table 150. Tapex Co., Ltd. QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 151. Tapex Co., Ltd. Recent Developments/Updates
Table 152. Tapex Co., Ltd. Competitive Strengths & Weaknesses
Table 153. EPSOL Co., Ltd. Basic Information, Manufacturing Base and Competitors
Table 154. EPSOL Co., Ltd. Major Business
Table 155. EPSOL Co., Ltd. QFN Leadframe Backside Tape Product and Services
Table 156. EPSOL Co., Ltd. QFN Leadframe Backside Tape Production (K Sqm), Price (US$/Sq m), Production Value (USD Million), Gross Margin and Market Share (2021-2026)
Table 157. EPSOL Co., Ltd. Recent Developments/Updates
Table 158. EPSOL Co., Ltd. Competitive Strengths & Weaknesses
Table 159. Global Key Players of QFN Leadframe Backside Tape Upstream (Raw Materials)
Table 160. Global QFN Leadframe Backside Tape Typical Customers
Table 161. QFN Leadframe Backside Tape Typical Distributors

+357 96 030922
info@marketpublishers.com

+357 96 030922
info@marketpublishers.com

List Of Figures

LIST OF FIGURES

Figure 1. QFN Leadframe Backside Tape Picture
Figure 2. World QFN Leadframe Backside Tape Production Value: 2021 & 2025 & 2032, (USD Million)
Figure 3. World QFN Leadframe Backside Tape Production Value and Forecast (2021-2032) & (USD Million)
Figure 4. World QFN Leadframe Backside Tape Production (2021-2032) & (K Sqm)
Figure 5. World QFN Leadframe Backside Tape Average Price (2021-2032) & (US$/Sq m)
Figure 6. World QFN Leadframe Backside Tape Production Value Market Share by Region (2021-2032)
Figure 7. World QFN Leadframe Backside Tape Production Market Share by Region (2021-2032)
Figure 8. North America QFN Leadframe Backside Tape Production (2021-2032) & (K Sqm)
Figure 9. Europe QFN Leadframe Backside Tape Production (2021-2032) & (K Sqm)
Figure 10. China QFN Leadframe Backside Tape Production (2021-2032) & (K Sqm)
Figure 11. Japan QFN Leadframe Backside Tape Production (2021-2032) & (K Sqm)
Figure 12. South Korea QFN Leadframe Backside Tape Production (2021-2032) & (K Sqm)
Figure 13. QFN Leadframe Backside Tape Market Drivers
Figure 14. Factors Affecting Demand
Figure 15. World QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)
Figure 16. World QFN Leadframe Backside Tape Consumption Market Share by Region (2021-2032)
Figure 17. United States QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)
Figure 18. China QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)
Figure 19. Europe QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)
Figure 20. Japan QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)
Figure 21. South Korea QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)
Figure 22. ASEAN QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)
Figure 23. India QFN Leadframe Backside Tape Consumption (2021-2032) & (K Sqm)

+357 96 030922
info@marketpublishers.com

Figure 24. Producer Shipments of QFN Leadframe Backside Tape by Manufacturer Revenue ($MM) and Market Share (%): 2025
Figure 25. Global Four-firm Concentration Ratios (CR4) for QFN Leadframe Backside Tape Markets in 2025
Figure 26. Global Four-firm Concentration Ratios (CR8) for QFN Leadframe Backside Tape Markets in 2025
Figure 27. United States VS China: QFN Leadframe Backside Tape Production Value Market Share Comparison (2021 & 2025 & 2032)
Figure 28. United States VS China: QFN Leadframe Backside Tape Production Market Share Comparison (2021 & 2025 & 2032)
Figure 29. United States VS China: QFN Leadframe Backside Tape Consumption Market Share Comparison (2021 & 2025 & 2032)
Figure 30. United States Based Manufacturers QFN Leadframe Backside Tape Production Market Share 2025
Figure 31. China Based Manufacturers QFN Leadframe Backside Tape Production Market Share 2025
Figure 32. Rest of World Based Manufacturers QFN Leadframe Backside Tape Production Market Share 2025
Figure 33. World QFN Leadframe Backside Tape Production Value by Adhesive Type, (USD Million), 2021 & 2025 & 2032
Figure 34. World QFN Leadframe Backside Tape Production Value Market Share by Adhesive Type in 2025
Figure 35. Silicone Adhesive
Figure 36. Acrylic Adhesive
Figure 37. Epoxy-modified Adhesive
Figure 38. Hybrid Adhesive
Figure 39. Others
Figure 40. World QFN Leadframe Backside Tape Production Market Share by Adhesive Type (2021-2032)
Figure 41. World QFN Leadframe Backside Tape Production Value Market Share by Adhesive Type (2021-2032)
Figure 42. World QFN Leadframe Backside Tape Average Price by Adhesive Type (2021-2032) & (US$/Sq m)
Figure 43. World QFN Leadframe Backside Tape Production Value by Base Film, (USD Million), 2021 & 2025 & 2032
Figure 44. World QFN Leadframe Backside Tape Production Value Market Share by Base Film in 2025
Figure 45. Polyimide Film
Figure 46. Polyester Film

+357 96 030922
info@marketpublishers.com

Figure 47. Fluoropolymer Film
Figure 48. Composite Film
Figure 49. Others
Figure 50. World QFN Leadframe Backside Tape Production Market Share by Base Film (2021-2032)
Figure 51. World QFN Leadframe Backside Tape Production Value Market Share by Base Film (2021-2032)
Figure 52. World QFN Leadframe Backside Tape Average Price by Base Film (2021-2032) & (US$/Sq m)
Figure 53. World QFN Leadframe Backside Tape Production Value by Heat Resistance, (USD Million), 2021 & 2025 & 2032
Figure 54. World QFN Leadframe Backside Tape Production Value Market Share by Heat Resistance in 2025
Figure 55. Below 200°C
Figure 56. 200–230°C
Figure 57. 230–260°C
Figure 58. Above 260°C
Figure 59. World QFN Leadframe Backside Tape Production Market Share by Heat Resistance (2021-2032)
Figure 60. World QFN Leadframe Backside Tape Production Value Market Share by Heat Resistance (2021-2032)
Figure 61. World QFN Leadframe Backside Tape Average Price by Heat Resistance (2021-2032) & (US$/Sq m)
Figure 62. World QFN Leadframe Backside Tape Production Value by Application, (USD Million), 2021 & 2025 & 2032
Figure 63. World QFN Leadframe Backside Tape Production Value Market Share by Application in 2025
Figure 64. QFN Packaging
Figure 65. DFN Packaging
Figure 66. SON Packaging
Figure 67. Mini-QFN Packaging
Figure 68. Leadless Power Package
Figure 69. Others
Figure 70. World QFN Leadframe Backside Tape Production Market Share by Application (2021-2032)
Figure 71. World QFN Leadframe Backside Tape Production Value Market Share by Application (2021-2032)
Figure 72. World QFN Leadframe Backside Tape Average Price by Application (2021-2032) & (US$/Sq m)

+357 96 030922
info@marketpublishers.com

Figure 73. QFN Leadframe Backside Tape Industry Chain
Figure 74. QFN Leadframe Backside Tape Procurement Model
Figure 75. QFN Leadframe Backside Tape Sales Model
Figure 76. QFN Leadframe Backside Tape Sales Channels, Direct Sales, and Distribution
Figure 77. Methodology
Figure 78. Research Process and Data Source

+357 96 030922
info@marketpublishers.com

I would like to order

Product name: Global QFN Leadframe Backside Tape Supply, Demand and Key Producers, 2026-2032

Product link: https://marketpublishers.com/r/GB0E22C25349EN.html

Price: US$ 4,480.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:
info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page https://marketpublishers.com/r/GB0E22C25349EN.html